

DESCRIPTION

The SPN7002U is the N-Channel enhancement mode field effect transistors are produced using high cell density DMOS technology. These products have been designed to minimize on-state resistance while provide rugged, reliable, and fast switching performance. They can be used in most applications requiring up to 640mA DC and can deliver pulsed currents up to 950mA. These products are particularly suited for low voltage, low current applications such as small servo motor control, power MOSFET gate drivers, and other switching applications.

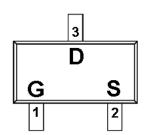
APPLICATIONS

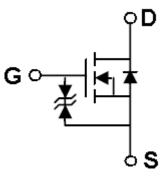
- Drivers: Relays, Solenoids, Lamps, Hammers, Display, Memories, Transistors, etc.
- High saturation current capability. Direct Logic-Level Interface: TTL/CMOS
- Battery Operated Systems
- Solid-State Relays

FEATURES

- 60V/0.50A, RDS(ON)= $2.0\Omega@VGS=10V$
- 60V/0.20A, RDS(ON)= $4.0\Omega(a)VGS=4.5V$
- ◆ Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- ♦ SOT-323 package design

PIN CONFIGURATION(SOT-323)





PART MARKING



PIN DESCRIPTION					
Pin	Symbol	Description			
1	G	Gate			
2	S	Source			
3	D	Drain			

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN7002US32RGB	SOT-323	1UXX

SPN7002US32RGB: Tape Reel; Pb – Free; Halogen – Free

ABSOULTE MAXIMUM RATINGS (TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit	
Drain-Source Voltage		Vdss	60	V
Gate –Source Voltage - Continuous		VGSS	±20	V
Continuous Drain Current(TJ=150°€)	Ta=25°C	ID	0.64	A
Pulsed Drain Current (*)		Ірм	0.95	A
Power Dissipation	TA=25°C	PD	1.35	W
Operating Junction Temperature	TJ	- 55 ∼ 150	$^{\circ}\!\mathbb{C}$	
Storage Temperature Range		Tstg	- 55 ∼ 150	$^{\circ}\!\mathbb{C}$
Thermal Resistance-Junction to Ambient		RθJA	375	°C/W

^(*) Pulse width limited by safe operating area

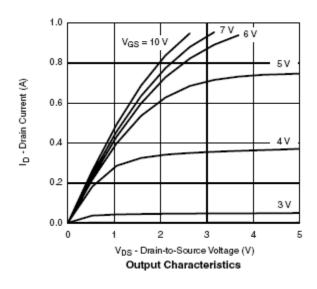
SPN7002U N-Channel Enhancement Mode MOSFET

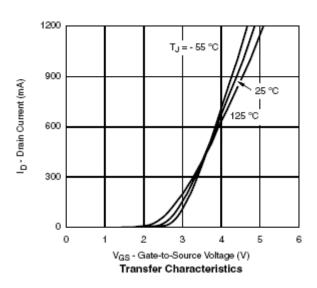
ELECTRICAL CHARACTERISTICS (Ta=25°C Unless otherwise noted)							
Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V(BR)DSS	Vgs=0V,Id=250Ua	60			V	
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=250uA	1.0	1.7	2.5	\ \ \ \ \	
Gate Leakage Current	Igss	V _{DS} =0V,V _{GS} =±20V			±30	uA	
Zero Gate Voltage Drain Current	Idss	V _{DS} =60V,V _{GS} =0V T _J =25°C			10	- uA	
		V _{DS} =48V,V _{GS} =0V T _J =70°C			100		
Drain-Source On-Resistance	RDS(on)	V _{GS} =10V,I _D =0.50A V _{GS} =4.5V,I _D =0.20A			2.0	Ω	
Forward Transconductance	Gfs(1)	$V_{DS} = 10 \text{ V}, I_{D} = 0.6 \text{ A}$		0.6		S	
Diode Forward Voltage	VsD(1)	$V_{GS} = 0 \text{ V}, I_{S} = 0.45 \text{A}$			1.2	V	
Dynamic							
Total Gate Charge	Qg			1.0	1.6	nC	
Gate-Source Charge	Qgs	$V_{DD} = 50 \text{ V}, I_{D} = 0.6 \text{ A}, V_{GS} = 4.5 \text{ V}$		0.5			
Gate-Drain Charge	Qgd	- V US - T.5 V		0.5] 	
Input Capacitance	Ciss	_		32	50	pF	
Output Capacitance	Coss	$V_{DS} = 25 \text{ V, } f = 1 \text{ MHz,}$ $V_{GS} = 0$		8			
Reverse Transfer Capacitance	Crss	- V G5 0		6			
Turn-On Time	td(on)			12		ns	
	tr	$V_{DD} = 30 \text{ V}, I_{D} = 0.6 \text{ A}$		10			
T Off Time	td(off)	$R_G = 3.3\Omega \text{ V}_{GS} = 10.0 \text{ V}$ $R_D = 52\Omega$		56			
Turn-Off Time	tf			29			

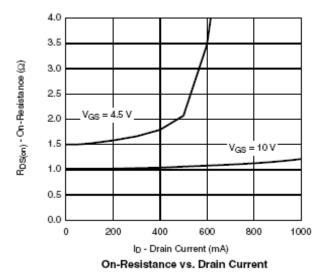
⁽¹⁾ Pulsed: Pulse duration = $300 \mu s$, duty cycle 1.5 %.

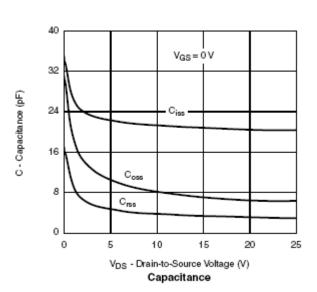
⁽²⁾ Pulse width limited by safe operating area.

TYPICAL CHARACTERISTICS

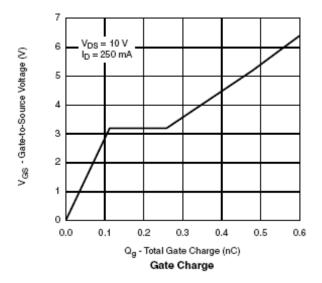


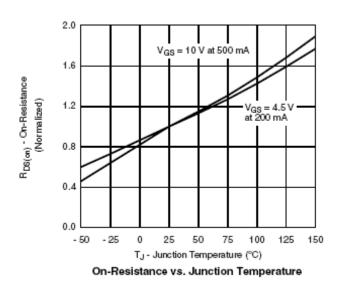


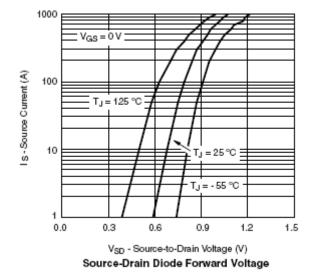


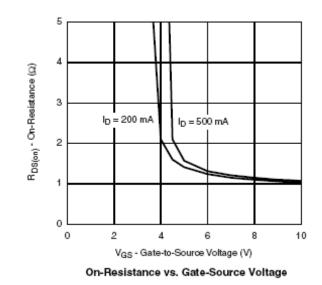


TYPICAL CHARACTERISTICS



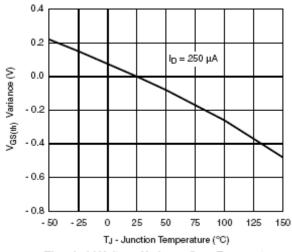






2.5

TYPICAL CHARACTERISTICS

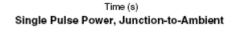


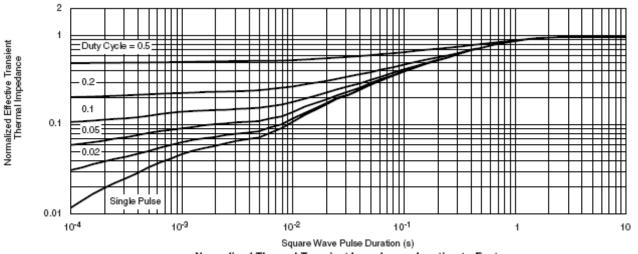
1.5 1.5 1.5 0.5 0.01

0.1

1 10 100 600

Threshold Voltage Variance Over Temperature

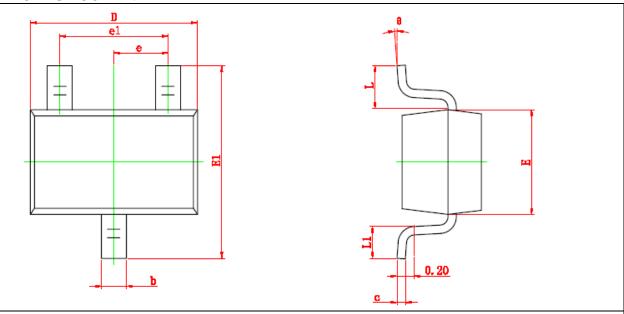


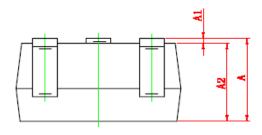


Normalized Thermal Transient Impedance, Junction-to-Foot



SOT-323 PACKAGE OUTLINE





Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.100	0.035	0.043	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.000	0.035	0.039	
b	0.200	0.400	0.008	0.016	
С	0.080	0.150	0.003	0.006	
D	2.000	2.200	0.079	0.087	
E	1.150	1.350	0.045	0.053	
E1	2.150	2.450	0.085	0.096	
е	0.650 TYP		0.026 TYP		
e1	1.200	1.400	0.047	0.055	
L	0.525 REF		0.021 REF		
L1	0.260	0.460	0.010	0.018	
θ	0°	8°	0°	8°	

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